

FORM PTO-1449	SERIAL NO. 10/500,196	CASE NO. 9905/23 (BIF023065/US)
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT	FILING DATE October 10, 2006	GROUP ART UNIT 2813
(use several sheets if necessary)		APPLICANT(S): Diem, et al.

REFERENCE DESIGNATION U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER <small>Number-Kind Code (if known)</small>	DATE	NAME	CLASS/ SUBCLASS	FILING DATE

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER <small>Number-Kind Code (if known)</small>	DATE	COUNTRY	CLASS/ SUBCLASS	TRANSLATION YES OR NO
	C1 97-13441	10/27/1997	France		Abstract
	C2 2 558 263	01/12/1984	France		Abstract

EXAMINER
INITIAL

OTHER ART – NON PATENT LITERATURE DOCUMENTS

(Include name of author, title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date page(s), volume-issue number(s), publisher, city and/or country where published.

C3	Wolffenbuttel, R.F., "Low-Temperature Silicon Wafer-To-Wafer Bonding Using Metal Intermediate Layers," Euroensors X, Leuven, Belgium, 8-11 September 1996, pp. 275-278.
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EXAMINER /Thanhha Pham/	DATE CONSIDERED 12/16/2009
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609;
 Draw line through citation if not in conformance and not considered. Include copy of this form with next
 communication to applicant.

ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. /T.S.P.